



* 所有原材料, 生产制程, 电镀必须符合ROHS要求

Specification

MATERIAL:
 Insulator: High Temperature Thermoplastic, UL 94V-0.
 Contact: Copper Alloy
 Shell: SUS

PLATING:
 Contact: Plated 50μ" Ni Overall Contact Au 1U
 Shell: Plated 50μ" Ni Overall
 Plated in Au Selective Contact Area

Electrical:
 Current Rating :0.5mA AC/DC max.
 Voltage Rating :125V AC/DC
 Ambient Temperature Range :-20° C~+60° C
 Storage Temperature Range :-40° C~+70° C
 Ambient Humidity Range :95% R.H. Max.
 Contact Resistance:100m Ω
 Insulation Resistance:1000M min./500VDC
 Mating Cycles:10,000 Insertions
 产品耐温度: 260° C ±0.5℃/1.0℃/0.5℃/0.5℃
 Mating Cycles:3,000-5,000 Insertions

SIM pin assignment	
PIN#	Name
C1	VCC 供电电压
C2	RST 重置
C3	CLK 时钟
C5	GND 接地
C6	VPP 程序电压
C7	I/O 输入输出

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DIMENSIONS UNIT: mm UNLESS OTHERWISE SPECIFIED DIMENSION TOLERANCE I.X: ± 0.15 I.XX: ± 0.30 I.XXX: ± 0.05 ANGULAR: ± 1°	PRODUCT NAME: MICRO-SIM 卡座/PIN# 1.35±0.1 6 PIN XNT Edition PRODUCT NO.: 0121AAAA07A DRAWING NO.: XNT-0011	DRAWING: COCO CHECK: JANY APPROVED: 林心祥 DATE: 2012/04/10 DATE: 2012/04/11 DATE: 2012/04/11 SCALE: 1:1 DWG. ID: B PAGE: 1 of 1
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